

74LVX3245

8-Bit Dual Supply Translating Transceiver with 3-STATE Outputs

General Description

The LVX3245 is a dual-supply, 8-bit translating transceiver that is designed to interface between a 3V bus and a 5V bus in a mixed 3V/5V supply environment. The Transmit/Receive ($\overline{T/R}$) input determines the direction of data flow. Transmit (active-HIGH) enables data from A Ports to B Ports; Receive (active-LOW) enables data from B Ports to A Ports. The Output Enable input, when HIGH, disables both A and B Ports by placing them in a high impedance condition. The A Port interfaces with the 3V bus; the B Port interfaces with the 5V bus.

The LVX3245 is suitable for mixed voltage applications such as notebook computers using 3.3V CPU and 5V peripheral components.

Features

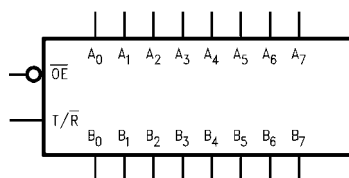
- Bidirectional interface between 3V and 5V buses
- Inputs compatible with TTL level
- 3V data flow at A Port and 5V data flow at B Port
- Outputs source/sink 24 mA
- Guaranteed simultaneous switching noise level and dynamic threshold performance
- Implements proprietary EMI reduction circuitry
- Functionally compatible with the 74 series 245

Ordering Code:

Order Number	Package Number	Package Description
74LVX3245WM	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74LVX3245QSC	MQA24	24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150" Wide
74LVX3245MTC	MTC24	24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

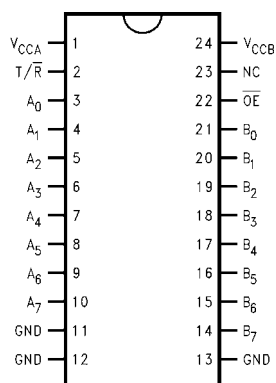
Logic Symbol/s



Pin Descriptions

Pin Names	Description
$\overline{OE}$	Output Enable Input
$\overline{T/R}$	Transmit/Receive Input
A ₀ –A ₇	Side A Inputs or 3-STATE Outputs
B ₀ –B ₇	Side B Inputs or 3-STATE Outputs

Connection Diagram/s

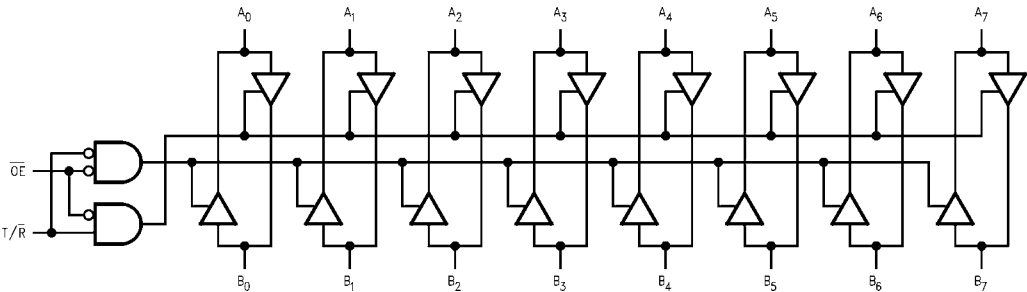


Truth Table/s

Inputs		Outputs
$\overline{OE}$	$T/\overline{R}$	
L	L	Bus B Data to Bus A
L	H	Bus A Data to Bus B
H	X	HIGH-Z State

H = HIGH Voltage Level
L = LOW Voltage Level
X = Immaterial

Logic Diagram/s



Absolute Maximum Ratings (Note 1)

Supply Voltage (V_{CCA}, V_{CCB})	-0.5V to +7.0V
DC Input Voltage (V_I) @ $\overline{OE}$, $T/\overline{R}$	-0.5V to $V_{CCA} + 0.5V$
DC Input/Output Voltage (V_{IO})	
@ A_n	-0.5V to $V_{CCA} + 0.5V$
@ B_n	-0.5V to $V_{CCB} + 0.5V$
DC Input Diode Current (I_{IN})	
@ $\overline{OE}$, $T/\overline{R}$	± 20 mA
DC Output Diode Current (I_{OK})	± 50 mA
DC Output Source or Sink Current (I_O)	± 50 mA
DC V_{CC} or Ground Current	
per Output Pin (I_{CC} or I_{GND})	± 50 mA
and Max Current @ I_{CCA}	± 100 mA
@ I_{CCB}	± 200 mA
Storage Temperature Range (T_{STG})	-65°C to +150°C
DC Latch-Up Source or Sink Current	± 300 mA
Maximum Junction Temperature Under Bias (T_J)	+150°C

Recommended Operating Conditions (Note 2)

Supply Voltage	
V_{CCA}	2.7V to 3.6V
V_{CCB}	4.5V to 5.5V
Input Voltage (V_I) @ $\overline{OE}$, $T/\overline{R}$	0V to V_{CCA}
Input/Output Voltage (V_{IO})	
@ A_n	0V to V_{CCA}
@ B_n	0V to V_{CCB}
Free Air Operating Temperature (T_A)	-40°C to +85°C
Minimum Input Edge Rate ($\Delta t/\Delta V$)	8 ns/V
V_{IN} from 30% to 70% of V_{CC}	
V_{CC} @ 3.0V, 4.5V, 5.5V	

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: Unused Pins (inputs and I/Os) must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter		V _{CCA} (V)	V _{CCB} (V)	T _A = +25°C		T _A = -40°C to +85°C		Units	Conditions				
					Typ	Guaranteed Limits								
V _{IHA}	Minimum HIGH Level Input Voltage	A _n , T/R, OE	3.6 2.7	5.0 5.0		2.0 2.0	2.0 2.0	V	V _{OUT} ≤ 0.1V or ≥ V _{CC} - 0.1V					
V _{IHB}		B _n	3.3 3.3	4.5 5.5		2.0 2.0	2.0 2.0							
V _{ILA}		Maximum LOW Level Input Voltage	A _n , T/R, OE	3.6 2.7	5.0 5.0		0.8 0.8			0.8 0.8	V	V _{OUT} ≤ 0.1V or ≥ V _{CC} - 0.1V		
V _{ILB}			B _n	3.3 3.3	4.5 5.5		0.8 0.8			0.8 0.8				
V _{OHA}	Minimum HIGH Level Output Voltage			3.0 3.0 2.7 2.7	4.5 4.5 4.5 4.5	2.99 2.65 2.5 2.3	2.9 2.35 2.3 2.1	2.9 2.25 2.2 2.0	V	I _{OUT} = -100 μA I _{OH} = -24 mA I _{OH} = -12 mA I _{OH} = -24 mA				
V _{OHB}				3.0 3.0	4.5 4.5	4.5 4.25	4.4 3.86	4.4 3.76					V	I _{OUT} = -100 μA I _{OH} = -24 mA
V _{OLA}		Maximum LOW Level Output Voltage		3.0 3.0 2.7 2.7	4.5 4.5 4.5 4.5	0.002 0.21 0.11 0.22	0.1 0.36 0.36 0.42	0.1 0.44 0.44 0.5			V	I _{OUT} = 100 μA I _{OL} = 24 mA I _{OL} = 12 mA I _{OL} = 24 mA		
V _{OLB}				3.0 3.0	4.5 4.5	0.002 0.18	0.1 0.36	0.1 0.44						
I _{IN}	Maximum Input Leakage Current @ OE, T/R		3.6	5.5		±0.1	±1.0	μA	V _I = V _{CCB} , GND					
I _{OZA}	Maximum 3-STATE Output Leakage @ A _n		3.6	5.5		±0.5	±5.0	μA	V _I = V _{IL} , V _{IH} OE = V _{CCA} V _O = V _{CCA} , GND					
I _{OZB}	Maximum 3-STATE Output Leakage @ B _n	3.6	5.5		±0.5	±5.0	μA	V _I = V _{IL} , V _{IH} OE = V _{CCA} V _O = V _{CCB} , GND						

Symbol	Parameter		V _{CCA} (V)	V _{CCB} (V)	T _A = +25°C		T _A = -40°C to +85°C		Units	Conditions
					Typ	Guaranteed Limits				
I _{CC}	Maximum I _{CC} /Input @	B _n	3.6	5.5	1.0	1.35	1.5		mA	V _I = V _{CCB} - 2.1V
		A _n , T/R, OE	3.6	5.5		0.35	0.5		mA	V _I = V _{CCA} -0.6V
I _{CCA}	Quiescent V _{CCA} Supply Current		3.6	5.5		5	50		μA	A _n = V _{CCA} or GND B _n = V _{CCB} or GND, OE = GND, T/R = GND
I _{CCB}	Quiescent V _{CCB} Supply Current		3.6	5.5		8	80		μA	A _n = V _{CCA} or GND B _n = V _{CCB} or GND, OE = GND, T/R = V _{CCA}
V _{OLPA}	Quiet Output Maximum		3.3	5.0		0.8			V	(Note 3) (Note 4)
V _{OLPB}	Dynamic V _{OL}		3.3	5.0		1.5				
V _{OLVA}	Quiet Output Minimum		3.3	5.0		-0.8			V	(Note 3) (Note 4)
V _{OLVB}	Dynamic V _{OL}		3.3	5.0		-1.2				
V _{IHDA}	Minimum HIGH Level		3.3	5.0		2.0			V	(Note 3) (Note 5)
V _{IHDB}	Dynamic Input Voltage		3.3	5.0		2.0				
V _{ILDA}	Maximum LOW Level		3.3	5.0		0.8			V	(Note 3) (Note 5)
V _{ILDB}	Dynamic Input Voltage		3.3	5.0		0.8				

Note 3: Worst case package.

Note 4: Max number of outputs defined as (n). Data inputs are driven 0V to V_{CC} level; one output at GND.

Note 5: Max number of Data Inputs (n) switching. (n-1) inputs switching 0V to V_{CC} level. Input-under-test switching: V_{CC} level to threshold (V_{IHD}), 0V to threshold (V_{ILD}), f = 1 MHz.

AC Electrical Characteristics

Symbol	Parameters	T _A = +25°C C _L = 50 pF V _{CCA} = 3.3V (Note 6) V _{CCB} = 5.0V (Note 7)			T _A = -40°C to +85°C C _L = 50 pF V _{CCA} = 3.3V (Note 6) V _{CCB} = 5.0V (Note 7)		T _A = -40°C to +85°C C _L = 50 pF V _{CCA} = 2.7V V _{CCB} = 5.0V (Note 7)		Units
		Min	Typ	Max	Min	Max	Min	Max	
t _{PHL}	Propagation Delay	1.0	5.4	8.0	1.0	8.5	1.0	9.0	ns
t _{PLH}	A to B	1.0	5.6	7.5	1.0	8.0	1.0	8.5	
t _{PHL}	Propagation Delay	1.0	5.1	7.5	1.0	8.0	1.0	8.5	ns
t _{PLH}	B to A	1.0	5.7	7.5	1.0	8.0	1.0	8.5	
t _{PZL}	Output Enable	1.0	4.8	8.0	1.0	8.5	1.0	9.0	ns
t _{PZH}	Time $\overline{OE}$ to B	1.0	6.3	8.5	1.0	9.0	1.0	9.5	
t _{PZL}	Output Enable	1.0	6.3	8.5	1.0	9.0	1.0	9.5	ns
t _{PZH}	Time $\overline{OE}$ to A	1.0	6.8	9.0	1.0	9.5	1.0	10.0	
t _{PHZ}	Output Disable	1.0	5.3	7.5	1.0	8.0	1.0	8.5	ns
t _{PLZ}	Time $\overline{OE}$ to B	1.0	4.2	7.0	1.0	7.5	1.0	8.0	
t _{PHZ}	Output Disable	1.0	5.3	8.0	1.0	8.5	1.0	9.0	ns
t _{PLZ}	Time $\overline{OE}$ to A	1.0	3.7	6.5	1.0	7.0	1.0	7.5	
t _{OSHL}	Output to Output								ns
t _{OSLH}	Skew (Note 8) Data to Output		1.0	1.5		1.5		1.5	

Note 6: Voltage Range 3.3V is 3.3V ± 0.3V.

Note 7: Voltage Range 5.0V is 5.0V ± 0.5V.

Note 8: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}). Parameter guaranteed by design.

Capacitance

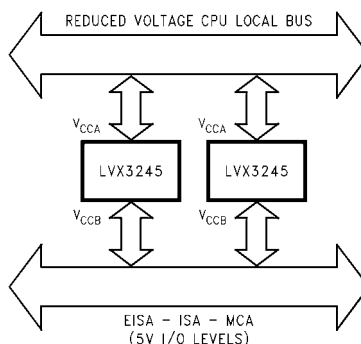
Symbol	Parameter	Typ	Units	Conditions
C_{IN}	Input Capacitance	4.5	pF	$V_{CC} = \text{Open}$
$C_{I/O}$	Input/Output Capacitance	15	pF	$V_{CCA} = 3.3V$ $V_{CCB} = 5.0V$
C_{PD}	Power Dissipation Capacitance (Note 9)	A $\rightarrow$ B	55	pF $V_{CCB} = 5.0V$ $V_{CCA} = 3.3V$
		B $\rightarrow$ A	40	

Note 9: C_{PD} is measured at 10 MHz

8-Bit Dual Supply Translating Transceiver

The LVX3245 is a dual supply device capable of bidirectional signal translation. This level shifting ability provides an efficient interface between low voltage CPU local bus with memory and a standard bus defined by 5V I/O levels. The device control inputs can be controlled by either the low voltage CPU and core logic or a bus arbitrator with 5V I/O levels.

Manufactured on a sub-micron CMOS process, the LVX3245 is ideal for mixed voltage applications such as notebook computers using 3.3V CPU's and 5V peripheral devices.



Power Up Considerations

To insure that the system does not experience unnecessary I_{CC} current draw, bus contention, or oscillations during power up, the following guidelines should be adhered to (refer to Table 1):

- Power up the control side of the device first. This is the V_{CCA} .
- $\overline{OE}$ should ramp with or ahead of V_{CCA} . This will help guard against bus contention.
- The Transmit/Receive control pin ($T/\overline{R}$) should ramp with V_{CCA} , this will ensure that the A Port data pins are con-

figured as inputs. With V_{CCA} receiving power first, the A I/O Port should be configured as inputs to help guard against bus contention and oscillations.

- A side data inputs should be driven to a valid logic level. This will prevent excessive current draw.

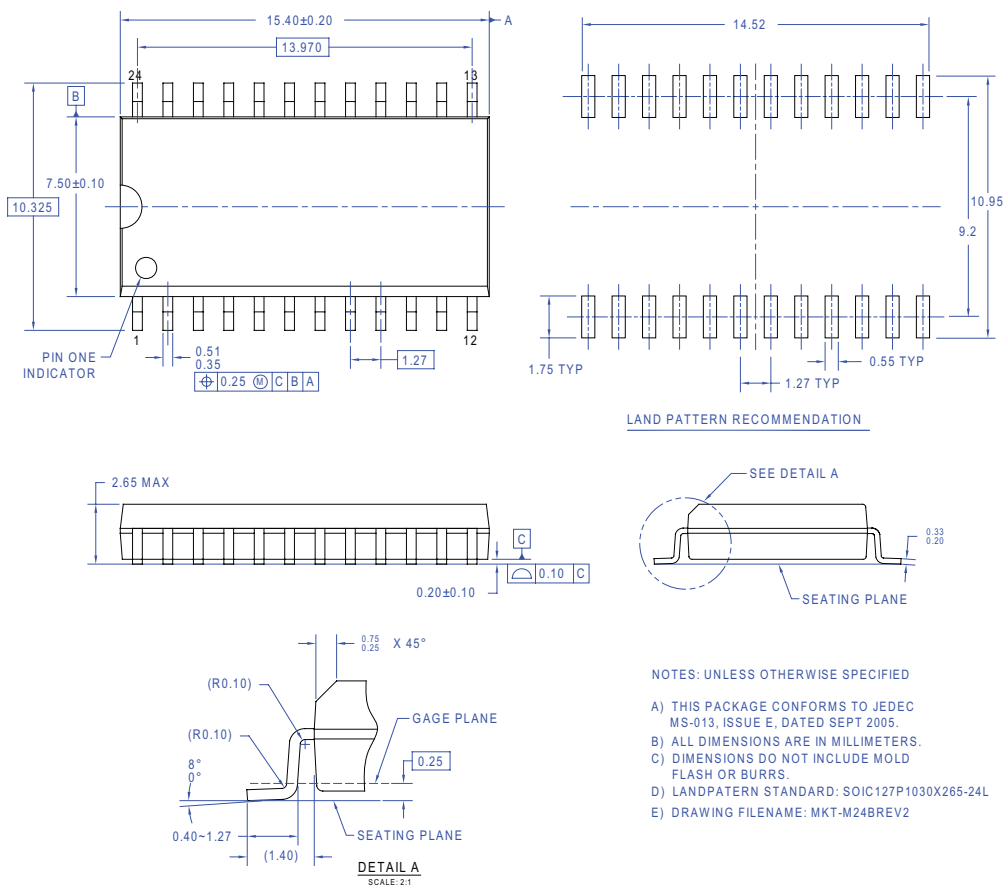
The above steps will ensure that no bus contention or oscillations, and therefore no excessive current draw occurs during the power up cycling of these devices. These steps will help prevent possible damage to the translator devices and potential damage to other system components.

TABLE 1. Low Voltage Translator Power Up Sequencing Table

Device Type	V_{CCA}	V_{CCB}	$T/\overline{R}$	$\overline{OE}$	A Side I/O	B Side I/O	Floatable Pin Allowed
74LVX3245	3V (power up 1st)	5V configurable	ramp with V_{CCA}	ramp with V_{CCA}	logic 0V or V_{CCA}	outputs	No

Please reference Application Note AN-5001 for more detailed information on using Fairchild's LVX Low Voltage Dual Supply CMOS Translating Transceivers.

Physical Dimensions



24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

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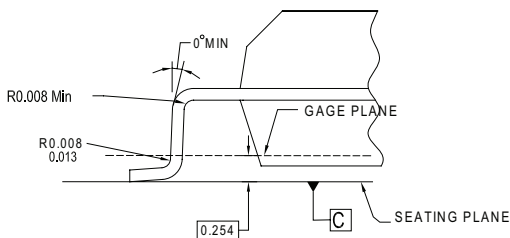
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DETAIL A

NOTES :

- A. THIS PACKAGE CONFORMS TO
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- B. ALL DIMENSIONS ARE IN MILLIMETERS
- C. DRAWING CONFORMS TO
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- F. DRAWING FILE NAME: MKT-MQA24REV2

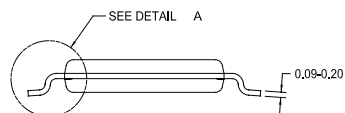
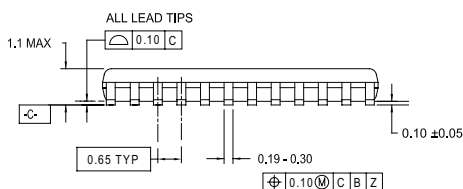
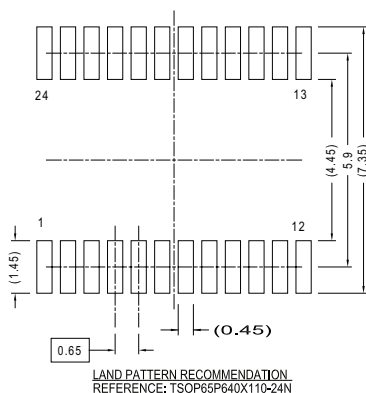
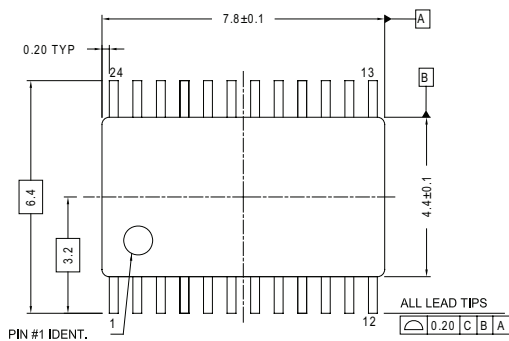


24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150" Wide

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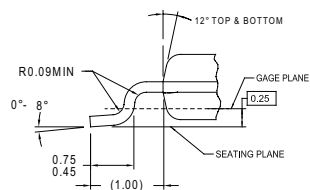


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- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1994
- E. DRAWING FILE NAME: MTC24REV4

MTC24REV4



DETAIL A

24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

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